

## ES1A - ES1D

### **Features**

- · For surface mount applications.
- · Glass passivated junction.
- · Low profile package.
- · Easy pick and place.
- · Built-in strain relief.
- Superfast recovery times for high efficiency.



SMA/DO-214AC COLOR BAND DENOTES CATHODE

### **Fast Rectifiers**

## Absolute Maximum Ratings\* T<sub>A</sub> = 25 ℃ unless otherwise noted

Symbol	Parameter	Value				Units
		1A	1B	1C	1D	Offics
$V_{RRM}$	Maximum Repetitive Reverse Voltage	50	100	150	200	V
I <sub>F(AV)</sub>	Average Rectified Forward Current, @ T <sub>A</sub> =120 ℃	1.0		А		
I <sub>FSM</sub>	Non-repetitive Peak Forward Surge Current 8.3 ms Single Half-Sine-Wave	30		А		
T <sub>stg</sub>	Storage Temperature Range	-50 to +150		°C		
T <sub>J</sub>	Operating Junction Temperature	-50 to +150		°C		

<sup>\*</sup>These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

### **Thermal Characteristics**

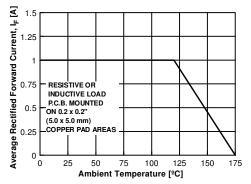
Symbol	Parameter	Value	Units
$P_{D}$	Power Dissipation	1.47	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient*	85	°C/W
$R_{\theta JL}$	Thermal Resistance, Junction to Lead*	35	°C/W

<sup>\*</sup>Device mounted on FR-4 PCB 0.013 mm.

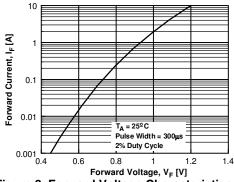
## **Electrical Characteristics** T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	bol Parameter		Device				Units	
			1A	1B	1C	1D		
V <sub>F</sub>	Forward Voltage @ 1.0 A		0.92		V			
t <sub>rr</sub>	Reverse Recovery Time 15 I <sub>F</sub> = 0.5 A, I <sub>B</sub> = 1.0 A, I <sub>BB</sub> = 0.25 A		5		ns			
I <sub>R</sub>	Reverse Current @ rated $V_R$ $T_A = 25^{\circ}C$ 5.0 $T_A = 100^{\circ}C$			μ <b>Α</b> μ <b>Α</b>				
Ст	Total Capacitance V <sub>R</sub> = 4.0 V, f = 1.0 MHz			7.0	0		pF	

## **Typical Characteristics**



**Figure 1. Forward Current Derating Curve** 



**Figure 2. Forward Voltage Characteristics** 

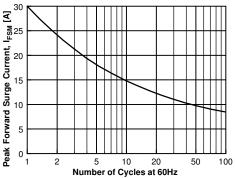


Figure 3. Non-Repetitive Surge Current

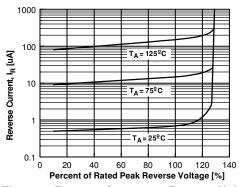
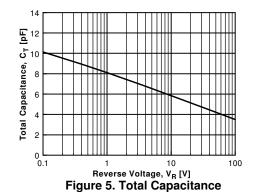


Figure 4. Reverse Current vs Reverse Voltage



50Ω NONINDUCTIVE

50Ω NONINDUCTIVE

DUT

Pulse Generator (Note 2)

S0Ω NONINDUCTIVE

(+)

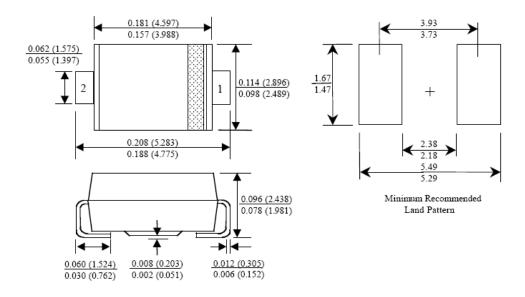
1. Rise time = 7.0 ns max; Input impedance = 1.0 megaohm 22 pf. 2. Rise time = 10 ns max; Source impedance = 50 ohms.

-1.0A -- 1.0cm -- SET TIME BASE FOR 5/10 ns/cm

**Reverse Recovery Time Characterstic and Test Circuit Diagram** 

# **Package Dimensions**

# SMA / DO - 214AC



Dimensions in Millimeters

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